

Depletion Mode MOSFET

IXTA6N50D2 IXTP6N50D2 IXTH6N50D2

 $V_{DSX} = 500V$ $I_{D(on)} \ge 6A$

 $R_{DS(on)} \leq 550 m\Omega$

N-Channel

Weight

Symbol

 $\boldsymbol{R}_{\text{DS}(o\underline{n})}$

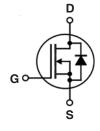
I_{D(on)}

TO-263

TO-220

TO-247

Test Conditions



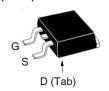
2.5

3.0

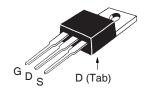
Characteristic Values

6

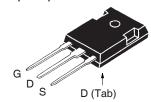
TO-263 AA (IXTA)



TO-220AB (IXTP)



TO-247 (IXTH)



G = Gate	D	=	Drain
S = Source	Tab	=	Drain

Test Conditions Symbol Maximum Ratings $T_{\perp} = 25^{\circ}C$ to $150^{\circ}C$ V_{DSX} 500 ٧ Continuous V_{gsx} ±20 Transient ±30 ٧ V_{GSM} $\mathbf{P}_{\scriptscriptstyle \mathrm{D}}$ $T_{c} = 25^{\circ}C$ W 300 T_{J} °С - 55 ... +150 $\mathbf{T}_{\mathrm{JM}}^{\mathrm{T}}$ °С 150 °С - 55 ... +150 °C 1.6mm (0.062 in.) from Case for 10s 300 T_{L} T_{SOLD} Plastic Body for 10s 260 °C M, Mounting Torque (TO-220 & TO-247) 1.13 / 10 Nm/lb.in.

(T₁ = 25°C, Unless Otherwise Specified) Max. Min. Typ. $\mathbf{BV}_{\mathrm{DSX}}$ $V_{GS} = -5V, I_{D} = 250\mu A$ 500 $V_{DS} = 25V, I_{D} = 250\mu A$ - 2.5 - 4.5 V_{GS(off)} $V_{GS} = \pm 20V, V_{DS} = 0V$ ±100 nA l_{GSX} $V_{DS} = V_{DSX}, V_{GS} = -5V$ 5 μΑ DSX(off) T, = 125°C 50 μA

Features

g

g

550 $m\Omega$

Α

- · Normally ON Mode
- International Standard Packages
- Molding Epoxies Meet UL94 V-0 Flammability Classification

Advantages

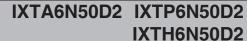
- · Easy to Mount
- · Space Savings
- · High Power Density

Applications

- Audio Amplifiers
- Start-up Circuits
- Protection Circuits
- Ramp Generators
- Current Regulators
- Active Loads

 $V_{GS} = 0V, I_{D} = 3A, Note 1$

 $V_{GS} = 0V$, $V_{DS} = 25V$, Note 1





Symbol (T _J = 25°C,	Test Conditions Unless Otherwise Specified)	Chara Min.	cteristic Typ.	Values Max.
g _{fs}	V _{DS} = 30V, I _D = 3A, Note 1	2.8	4.5	S
C _{iss}			2800	pF
C _{oss}	$V_{GS} = -10V, V_{DS} = 25V, f = 1MHz$		255	pF
C _{rss}			64	pF
t _{d(on)}	Resistive Switching Times		28	ns
t,	$V_{GS} = \pm 5V, V_{DS} = 250V, I_{D} = 3A$		72	ns
t _{d(off)}			82	ns
t,	$R_{\rm G} = 2.4\Omega$ (External)		43	ns
$Q_{g(on)}$			96	nC
Q _{gs}	$V_{GS} = \pm 5V, V_{DS} = 250V, I_{D} = 3A$		11	nC
Q_{gd}			48	nC
R _{thJC}				0.41 °C/W
R _{thCS}	TO-220 TO-247		0.50 0.21	°C/W °C/W

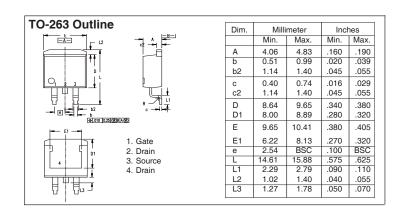
Safe-Operating-Area Specification

		Characteristic Values		
Symbol	Test Conditions	Min.	Тур.	Max.
SOA	$V_{DS} = 400V$, $I_D = 0.45A$, $T_C = 75$ °C, $Tp = 5$ s	180		W

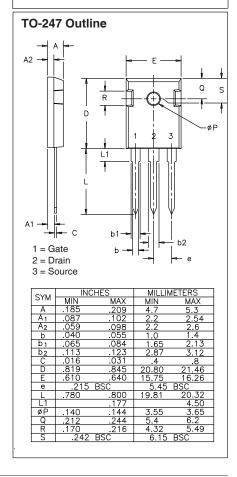
Source-Drain Diode

Symbol $(T_J = 25^\circ)$	Test Conditions Ch C, Unless Otherwise Specified) Min.		ic Values Max.
V _{SD}	$I_F = 6A, V_{GS} = -10V, \text{ Note 1}$	0.8	1.3 V
t _{rr} I _{RM} Q _{RM}	$ \begin{cases} I_F = 3A, -di/dt = 100A/\mu s \\ V_R = 100V, V_{GS} = -10V \end{cases} $	350 16 2.8	ns A µC

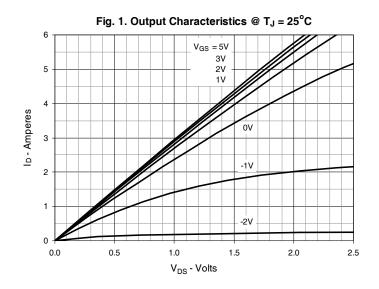
Note 1. Pulse test, $t \le 300\mu s$, duty cycle, $d \le 2\%$.

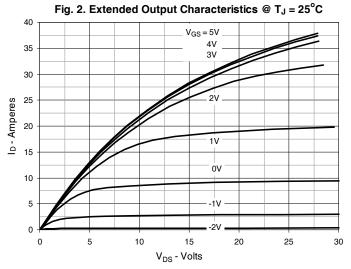


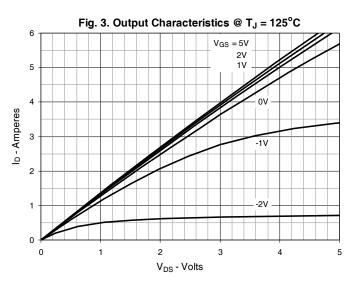
TO-220 Outline \mp + k (M) C A (S) 2 - Drain 1 - Gate Pins: 3 - Source INCHES MILLIME TERS MY2 MAX MIN MAX 4.83 .025 .045 .040 0.64 1.02 Ь1 .065 .022 14.73 .390 .420 9.91 10.66 .090 5.84 .161

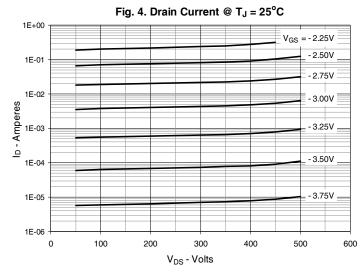


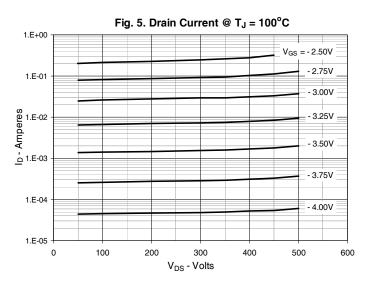


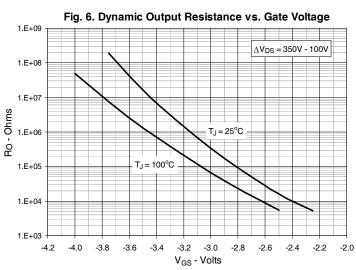




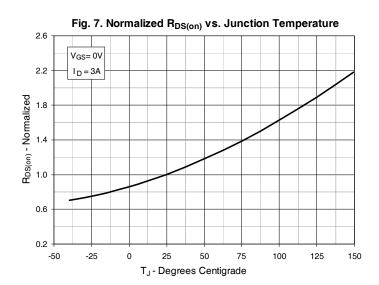


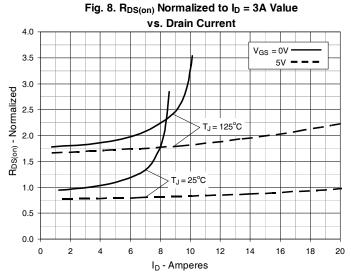


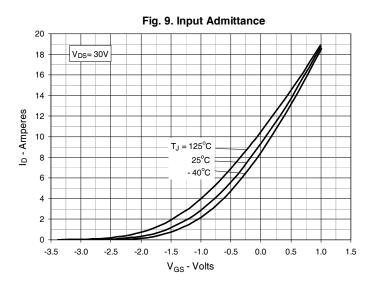


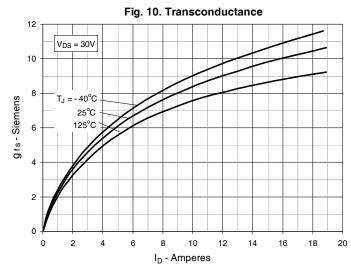


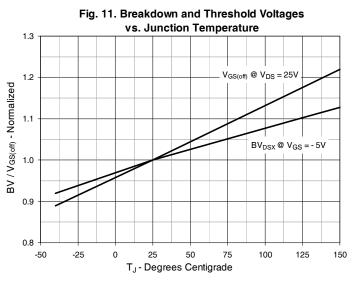


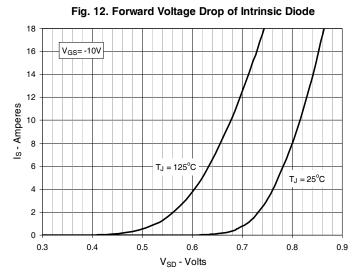






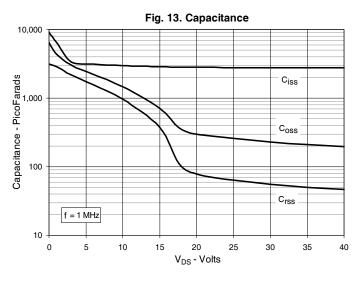






IXYS Reserves the Right to Change Limits, Test Conditions, $\$ and $\$ Dimensions.





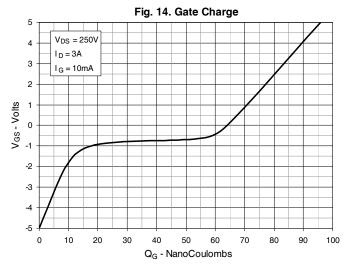


Fig. 15. Forward-Bias Safe Operating Area

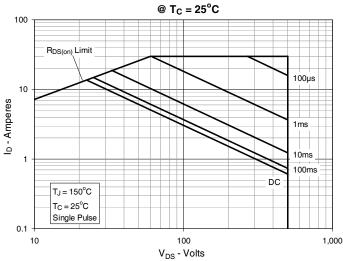


Fig. 16. Forward-Bias Safe Operating Area

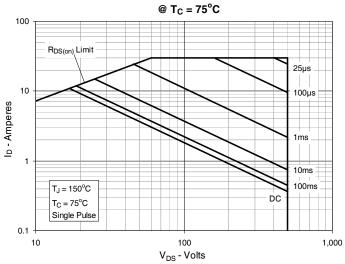


Fig. 17. Maximum Transient Thermal Impedance

